PC852 Series PC853/PC853H

Lead forming type (I type) and taping reel type (P type) are also available. (PC852I/PC852P/PC853I/PC853P)

PC8Q52

■ Features

1. High collector-emitter voltage

PC852 Series, PC853 ($V_{CEO}:300V$)

PC853H $(V_{CEO}: 350V)$

2. High current transfer ratio

(CTR: MIN. 1 000% at $I_F = 1 \text{mA}$, $V_{CE} = 2 \text{V}$)

3. High isolation voltage between input and output (V_{iso} : 5 000V $_{rms}$)

4. Compact dual-in-line package

PC852, PC853, PC853H (1-channel type)

Internal connection

High Collector-emitter Voltage Type Photocouplers

PC8D52 (2 channel type)

PC8D52 (2-channel type)

PC8Q52 (4-channel type)

5. Large collector power dissipation.

PC853, **PC853H** ($P_c : 300 \text{mW}$)

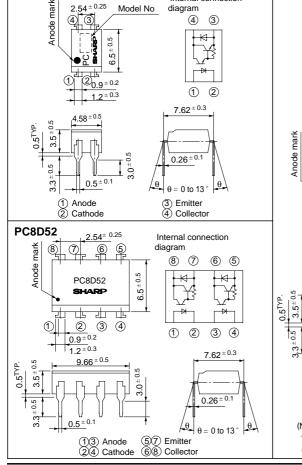
6. Recognized by UL (NO. E64380)

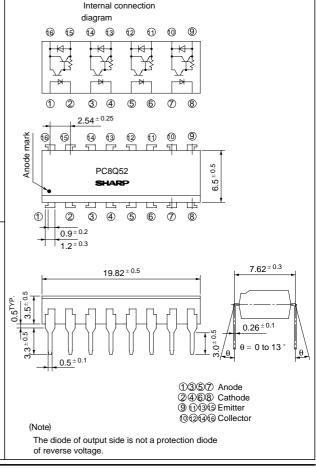
■ Applications

- 1. Telephone sets
- 2. Copiers, facsimiles
- 3. Interface with various power supply circuits, power distribution boards
- 4. Numerical control machines

(Unit: mm)

■ Outline Dimensions PC852/PC853/PC853H





■ Absolute Maximum Ratings

 $(Ta=25^{\circ}C)$

Parameter		Symbol	Rating			I I
			PC852 Series	PC853	PC853H	Unit
Input	Forward current	I_F	50	50		mA
	*1Peak forward current	I_{FM}	1	1		A
	Reverse voltage	V _R	6	6		V
	Power dissipation	P	70	70		mW
Output	Collector-emitter voltage	V _{CEO}	300	300	350	V
	Emitter-collector voltage	V _{ECO}	0.1	0.1		V
	Collector current	Ic	150	150		mA
	Collector power dissipation	Pc	150	300		mW
Total power dissipation		P tot	200	320		mW
*2Isolation voltage		V iso	5 000	5 000		V rms
Operating temperature		T opr	- 30 to + 100	- 30 to + 100		°C
Storage temperature		T stg	- 55 to + 125	- 55 to + 125		°C
*3Soldering temperature		T sol	260	260		°C

^{*1} Pulse width<=100 \mus, Duty ratio: 0.001

■ Electro-optical Characteristics

 $(Ta=25^{\circ}C)$

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		VF	$I_F = 10mA$	-	1.2	1.4	V
	Reverse current		I_R	$V_R = 4V$	-	-	10	μΑ
	Terminal capacitance		C_t	V = 0, $f = 1kHz$	-	30	250	pF
Output	Collector dark current		I_{CEO}	$V_{CE} = 200V, I_F = 0$	-	-	2 x 10 -7	A
Transfer characteristics	Current transfer ratio		CTR	$I_F = 1mA$, $V_{CE} = 2V$	1 000	4 000	15 000	%
	Collector-emitter saturation voltage		V _{CE(sat)}	$I_F = 20mA$, $I_C = 100mA$	-	-	1.2	V
	Isolation resistance		R _{ISO}	DC500V, 40 to 60% RH	5 x 10 ¹⁰	1011	-	Ω
	Floating capacitance		$C_{\rm f}$	V = 0, f = 1MHz	-	0.6	1.0	pF
	Cut-off frequency		fc	$V_{CE} = 2V$, $I_{C} = 20mA$, $R_{L} = 100 \Omega$, $-3dB$	1	7	-	kHz
	Response time	Rise time	t _r	$V_{CE} = 2V$, $I_C = 20mA$	-	100	300	μs
		Fall time	t _f	$R_L = 100 \Omega$	-	20	100	μs

^{*2 40} to 60% RH, AC for 1 minute

^{*3} For 10 seconds

Fig. 1 Forward Current vs.

Ambient Temperature

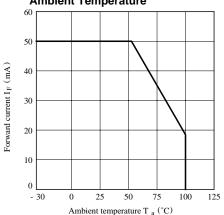


Fig. 2-b Collector Power Dissipation vs.
Ambient Temperature

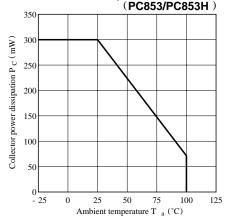


Fig. 4 Forward Current vs. Forward Voltage

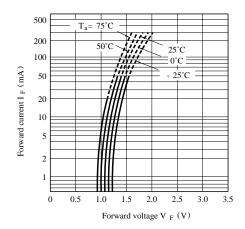


Fig. 2-a Collector Power Dissipation vs.
Ambient Temperature

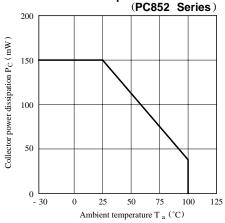


Fig. 3 Peak Forward Current vs. Duty Ratio

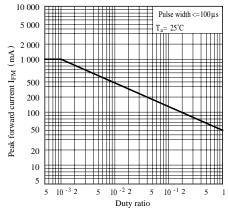


Fig. 5-a Current Transfer Ratio vs. Forward Current

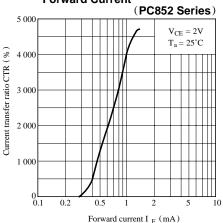


Fig. 5-b Current Transfer Ratio vs. **Forward Current**

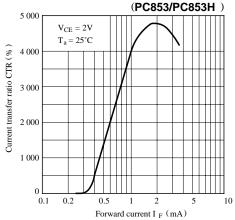


Fig. 6-b Collector Current vs. Collector-emitter Voltage (PC853 / PC853H)

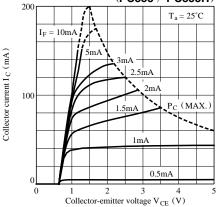


Fig. 8 Collector-emitter Saturation Voltage vs. Ambient Temperature

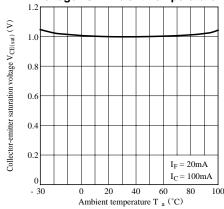


Fig. 6-a Collector Current vs.

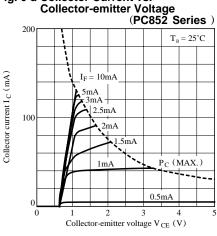


Fig. 7 Relative Current Transfer Ratio vs. **Ambient Temperature**

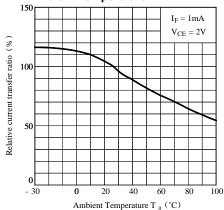


Fig. 9 Collector Dark Current vs.

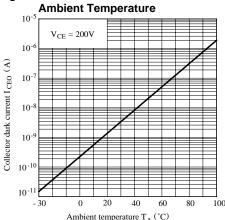


Fig.10 Response Time vs. Load Resistance

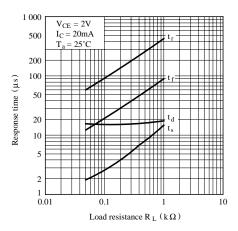
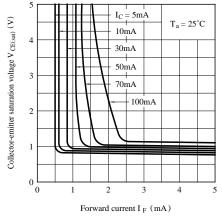
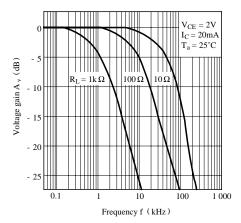


Fig.12 Collector-emitter Saturation Voltage vs. Forward Current



• Please refer to the chapter "Precautions for Use"

Fig.11 Frequency Response



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